



IEC SYSTEM FOR MUTUAL RECOGNITION OF TEST CERTIFICATES FOR ELECTRICAL EQUIPMENT (IECEE) CB SCHEME

SYSTEME CEI DACCEPTATION MUTUELLE DE CERTIFICATS DESSAIS DES EQUIPEMENTS ELECTRIQUES (IECEE) METHODE OC

CB TEST CERTIFICATE CERTIFICAT D'ESSAI OC

Product Produit

Name and address of the applicant Nom et adresse du demandeur

Name and address of the manufacturer Nom et adresse du fabricant

Name and address of the factory Nom et adresse de l'usine

Note: When more than one factory, please report on page 2 Note: Lorsque il y plus d'une usine, veuillez utiliser la deuxième page

Ratings and principal characteristics

Valeurs nominales et caractéristiques principales

Trademark (if any) Marque de fabrique (si elle existe)

Type of Manufacturer's Testing Laboratories used Type de programme du laboratoire d'essais constructeur

Model / Type Ref. Ref. De type

Additional information (if necessary may also be reported on page 2)

Les informations complémentaires (si nécessaire, peuvent être indiqués sur la deuxième page

A sample of the product was tested and found to be in conformity with

Un échantillon de ce produit a été essayé et a été considéré conforme à la

As shown in the Test Report Ref. No. which forms part of this Certificate

Comme indiqué dans le Rapport dessais numéro de référence qui constitue partie de ce Certificat

Integrated Circuit with active X capacitor discharge function

Texas Instruments Incorporated 12500 TI Boulevard, MS K1-20 Dallas, TX 75243 USA

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Texas Instruments Malaysia Sdn Bhd No.1 Lorong Enggang 33, Ampang/Ulu Klang, Kuala Lumpur, 54200 Malaysia

Additional information on page 2

264V AC maximum (Applicable for use with mains supply 85-264Vac, 47-63Hz)



UCC25630

Component for building-in. May be provided with additional suffix characters that do not affect the safety function of the component

Additional information on page 2

1/1

IEC 60950-1:2005, IEC 60950-1:2005/AMD1:2009, IEC 60950-1:2005/AMD2:2013

325707

This CB Test Certificate is issued by the National Certification Body Ce Certificat dessai OC est établi par l'Organisme National de Certification



Gaustadalléen 30 NO-0373 Oslo, Norway

Date: 29-08-2017

Jiyea Gim

Signature: Jiyea Gim

Certification Department

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